## **SKET 330**



# SEMIPACK<sup>®</sup> 4

#### **SKET 330**

#### Features

- Heat transfer through aluminium nitride ceramic isolated metal baseplate
- Precious metal pressure contacts for high reliability
- Thyristor with amplifying gate
- UL recognized, file no. E 63 532

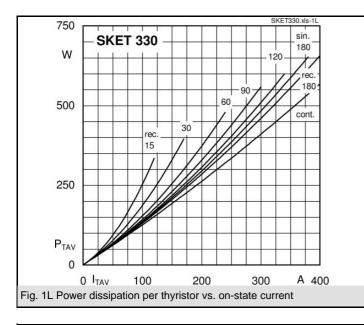
#### **Typical Applications\***

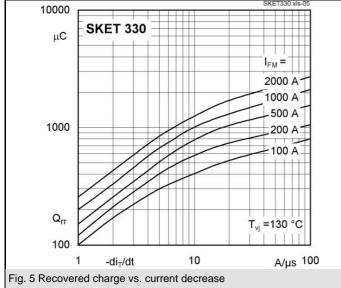
- DC motor control
  (e. g. for machine tools)
- Temperature control (e. g. for ovens, chemical processes)
- Professional light dimming (studios, theaters)
- 1) See the assembly instructions

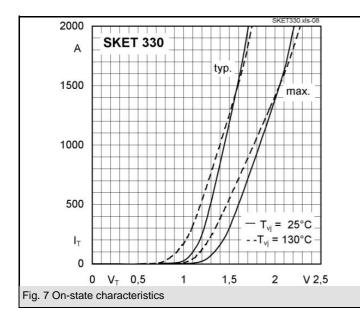
| V <sub>RSM</sub> | V <sub>RRM</sub> , V <sub>DRM</sub> | I <sub>TRMS</sub> = 600 A (maximum value for continuous operation) |  |  |
|------------------|-------------------------------------|--|--|--|
| V                | V                                   | I <sub>TAV</sub> = 330 A (sin. 180; T <sub>c</sub> = 78 °C)        |  |  |
| 900              | 800                                 | SKET 330/08E   |  |  |
| 1300             | 1200                                | SKET 330/12E   |  |  |
| 1500             | 1400                                | SKET 330/14E   |  |  |
| 1700             | 1600                                | SKET 330/16E   |  |  |
| 1900             | 1800                                | SKET 330/18E   |  |  |
| 2100             | 2000                                | SKET 330/20E   |  |  |
| 2300             | 2200                                | SKET 330/22E   |  |  |
|                  |                                     |  |  |  |

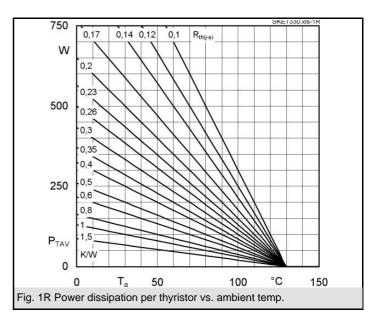
| Symbol                            | Conditions  | Values                 | Units |
|-----------------------------------|---|------------------------|-------|
| I <sub>TAV</sub>                  | sin. 180; T <sub>c</sub> = 85 (100) °C;                                     | 295 (210 )             | А     |
| I <sub>D</sub>                    | P16/300F; T <sub>a</sub> = 35 °C; B2 / B6                                   | 530 / 665              | Α     |
| I <sub>RMS</sub>                  | P16/400F; T <sub>a</sub> = 35 °C; W1 / W3                                   | 685 / 3 * 550          | А     |
| I <sub>TSM</sub>                  | T <sub>vi</sub> = 25 °C; 10 ms  | 9000                   | Α     |
|                                   | T <sub>vi</sub> = 130 °C; 10 ms   | 8000                   | A     |
| i²t                               | T <sub>vi</sub> = 25 °C; 8,3 10 ms  | 405000                 | A²s   |
|                                   | T <sub>vj</sub> = 130 °C; 8,3 10 ms   | 320000                 | A²s   |
| V <sub>T</sub>                    | T <sub>vi</sub> = 25 °C; I <sub>T</sub> = 1500 A                            | max. 2,05              | V     |
| V <sub>T(TO)</sub>                | T <sub>vi</sub> = 130 °C  | max. 1,2               | V     |
| r <sub>T</sub>                    | T <sub>vi</sub> = 130 °C  | max. 0,55              | mΩ    |
| I <sub>DD</sub> ; I <sub>RD</sub> | $T_{vj}$ = 130 °C; $V_{RD}$ = $V_{RRM}$ ; $V_{DD}$ = $V_{DRM}$              | max. 200               | mA    |
| t <sub>gd</sub>                   | T <sub>vj</sub> = 25 °C; I <sub>G</sub> = 1 A; di <sub>G</sub> /dt = 1 A/μs | 1                      | μs    |
| t <sub>gr</sub>                   | $V_{\rm D} = 0.67 * V_{\rm DRM}$  | 2                      | μs    |
| (di/dt) <sub>cr</sub>             | T <sub>vi</sub> = 130 °C  | max. 125               | A/µs  |
| (dv/dt) <sub>cr</sub>             | T <sub>vi</sub> = 130 °C  | max. 1000              | V/µs  |
| t <sub>q</sub>                    | T <sub>vi</sub> = 130 °C ,  | 150 200                | μs    |
| I <sub>H</sub>                    | T <sub>vi</sub> = 25 °C; typ. / max.  | 150 / 500              | mA    |
| I <sub>L</sub>                    | T <sub>vj</sub> = 25 °C; R <sub>G</sub> = 33 Ω; typ. / max.                 | 500 / 2000             | mA    |
| V <sub>GT</sub>                   | T <sub>vi</sub> = 25 °C; d.c.   | min. 3                 | V     |
| I <sub>GT</sub>                   | T <sub>vi</sub> = 25 °C; d.c.   | min. 200               | mA    |
| V <sub>GD</sub>                   | T <sub>vi</sub> = 130 °C; d.c.  | max. 0,25              | V     |
| I <sub>GD</sub>                   | T <sub>vj</sub> = 130 °C; d.c.  | max. 10                | mA    |
| R <sub>th(j-c)</sub>              | cont.   | 0,09                   | K/W   |
| R <sub>th(j-c)</sub>              | sin. 180  | 0,095                  | K/W   |
| R <sub>th(j-c)</sub>              | rec. 120  | 0,11                   | K/W   |
| R <sub>th(c-s)</sub>              |   | 0,02                   | K/W   |
| T <sub>vj</sub>                   |   | - 40 + 130             | °C    |
| T <sub>stg</sub>                  |   | - 40 + 130             | °C    |
| V <sub>isol</sub>                 | a. c. 50 Hz; r.m.s.; 1s / 1 min.  | 3600 / 3000            | V~    |
| M <sub>s</sub>                    | to heatsink   | 5 ± 15 % <sup>1)</sup> | Nm    |
| M <sub>t</sub>                    | to terminal   | 17 ± 15 %              | Nm    |
| а                                 |   | 5 * 9,81               | m/s²  |
| m                                 | approx.   | 940                    | g     |
| Case                              |   | A 36                   |       |
|                                   |   |                        |       |
|                                   |   |                        |       |
|                                   |   |                        |       |

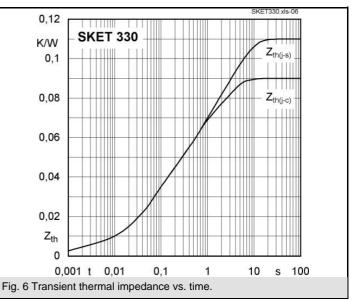


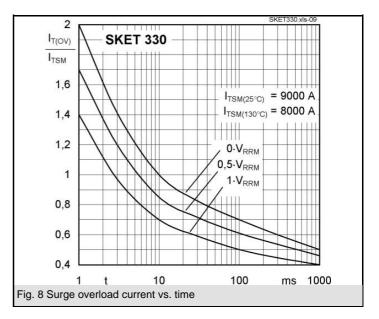




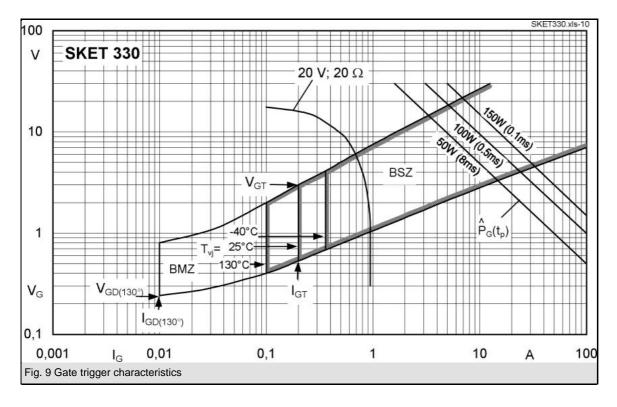


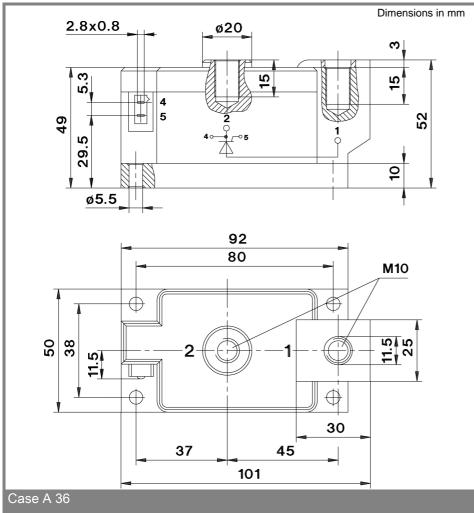






### **SKET 330**





\* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON

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products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our staff.